

RS2ABF thru RS2MABF

Surface Mount Glass Passivated Super Fast Rectifiers

Reverse Voltage 50 to 1000V Forward Current 2.0A

FEATURES

- * Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- * High temperature metallurgically bonded construction
- * Cavity-free glass passivated junction
- * Capable of meeting environmental standards of MIL-S-19500
- * Fast Switching for high efficiency
- * Typical IR less than 1.0 μ A
- * High temperature soldering guaranteed: 260°C/10 seconds

Mechanical Data

Case: JEDEC SMB-FL, molded plastic over glass die

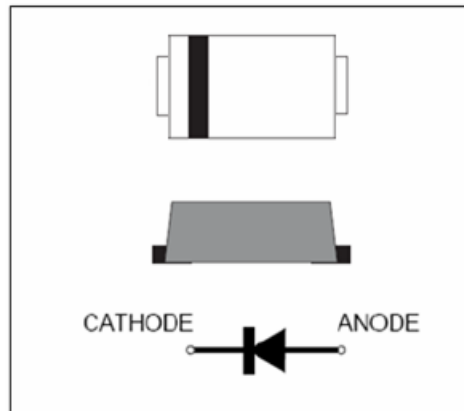
Terminals: Plated leads, solderable per MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end

Mounting Position: Any

Weight: 0.066 g

Handling precaution: None



we declare that the material of product is halogen free (green epoxy compound).

1. Maximum & Thermal Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

Parameter Symbol	symbol	RS2ABF	RS2BBF	RS2DBF	RS2GBF	RS2JBF	RS2KBF	RS2MBF	RS2MPBF	Unit
Device marking code		RS2A	RS2B	RS2D	RS2G	RS2J	RS2K	RS2M	RS2MP	
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	1000	V
Maximum RSM voltage	V_{RSM}	35	70	140	280	420	560	700	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	1000	V
Maximum average forward rectified current 0.375" (9.5mm) lead length at $T_c = 75^\circ\text{C}$	$I_F(AV)$	2.0								A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	70								A
Typical thermal resistance (Note 2)	R θ JA R θ JC	135 25								°C/W
Operating junction and storage temperature range	TJ, TSTG	-50 to +150								°C

Electrical Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

Parameter Symbol	symbol	RS2ABF	RS2BBF	RS2DBF	RS2GBF	RS2JBF	RS2KBF	RS2MBF	RS2MPBF	Unit
Maximum instantaneous forward voltage at 2.0A	V_F	1.3								V
Maximum DC reverse current $T_A = 25^\circ\text{C}$ at rated DC blocking voltage $T_J = 125^\circ\text{C}$	IR	5.0 100								μ A
Typical reverse recovery time (Note 1)	trr	150				500			250	ns
Typical junction capacitance at 4.0V, 1MHz	CJ	8.0								PF

NOTES:

1. $I_F = 0.5\text{A}$, $I_R = 1.0\text{A}$, $IRR = 0.25\text{A}$

2. 8.0mm 2 (.013mm thick) land areas

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2. Ratings and Characteristic Curves (TA = 25°C unless otherwise noted)

Fig. 1 - Forward Current Derating Curve

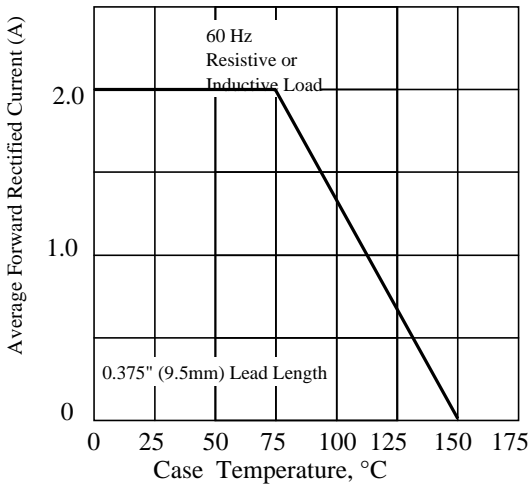


Fig. 2 - Maximum Non-repetitive Peak Forward Surge Current

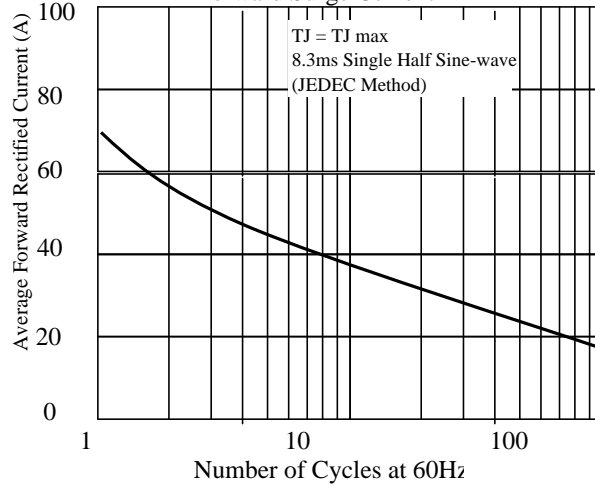


Fig 3. - Typical Instantaneous Forward Characteristics

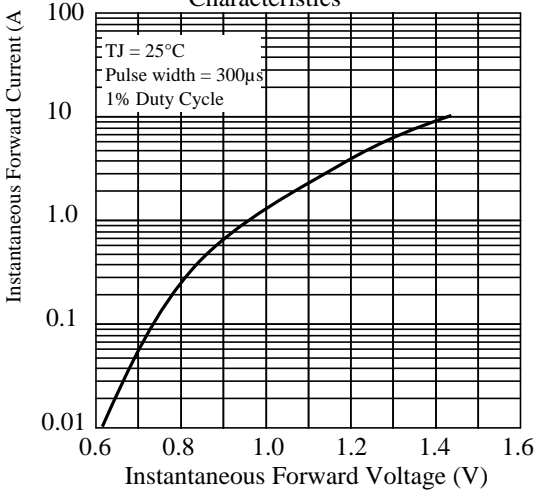


Fig 4. - Typical Reverse Characteristics

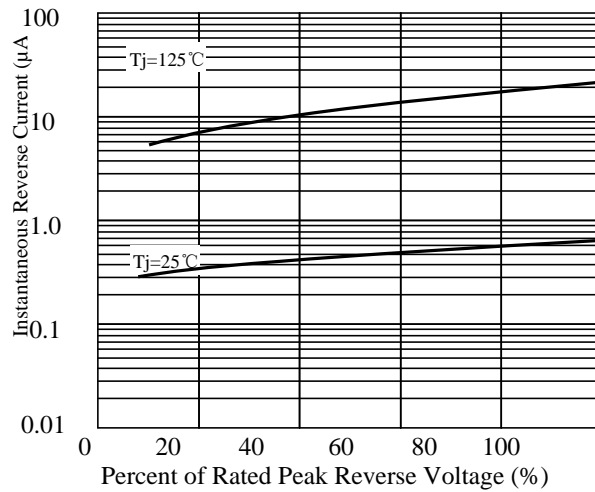


Fig 5. - typical transient thermal impedance

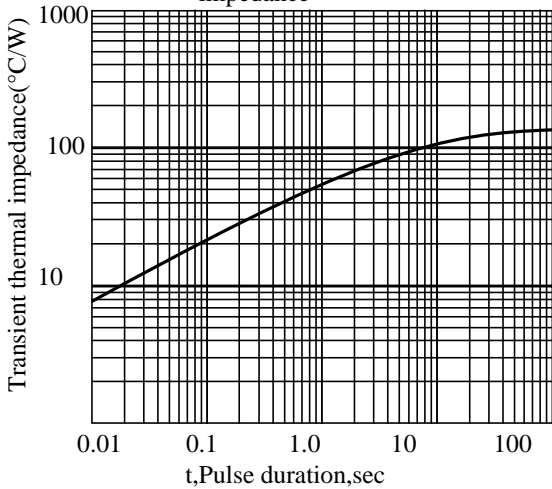
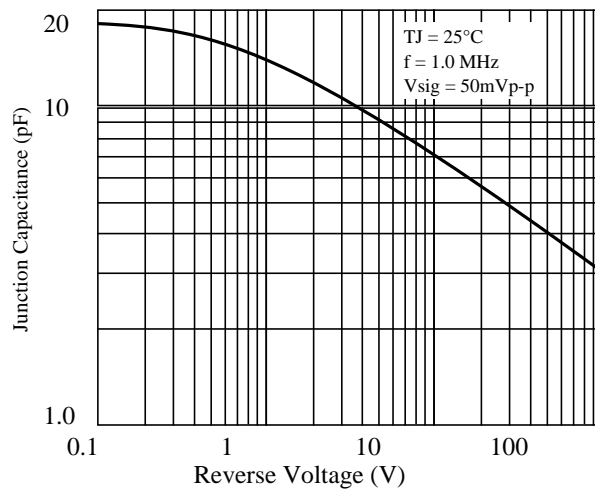


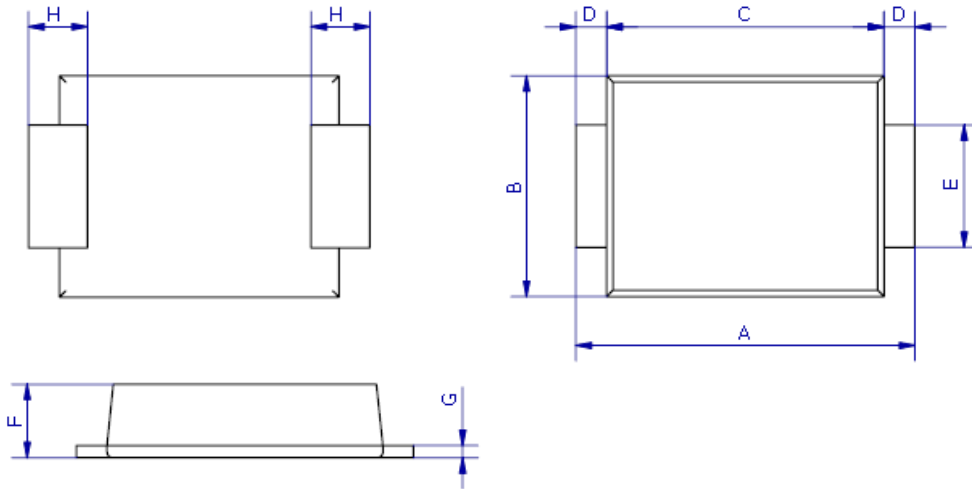
Fig 6. - Typical Junction Capacitance



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3. dimension:

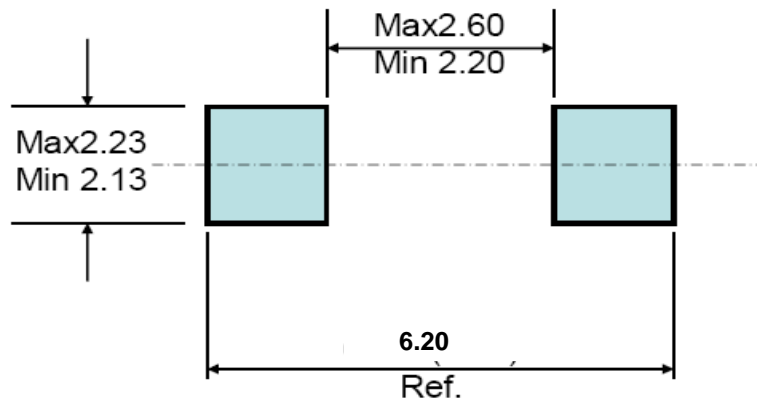
SMB-FL



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	5.3	5.7	0.209	0.224
B	3.4	3.8	0.134	0.150
C	4.3	4.7	0.169	0.185
D	0.45Typ		0.018Typ	
E	1.9	2.1	0.0748	0.08268
F	1.05	1.40	0.04134	0.05512
G	0.2	0.3	0.00591	0.00984
H	0.95Typ		0.037Typ	

Mounting Pad Layout

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4. Update Record

版次	更新记录	更新作者	更新日期
1	第一版	周杰	2014.04.30